

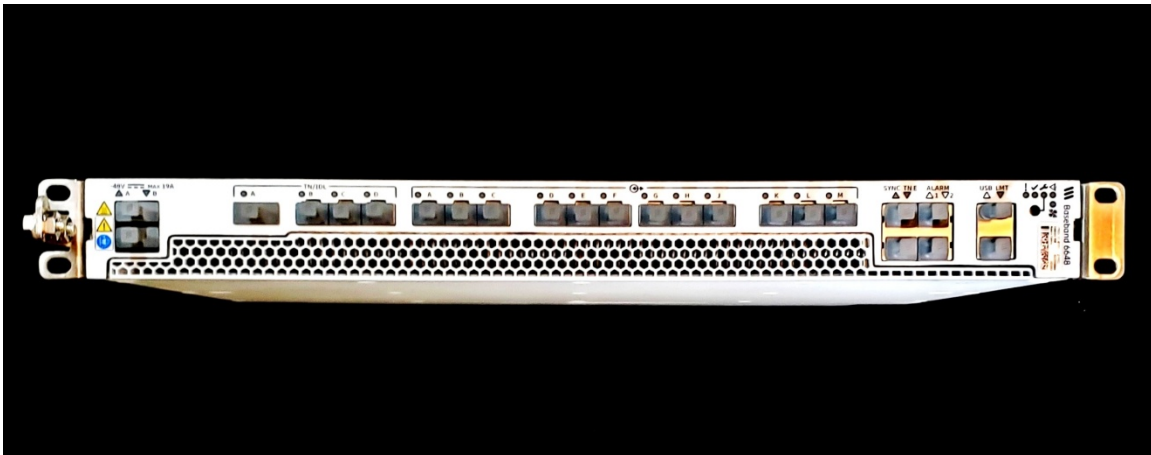
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Ericsson

5G NR Digital BBU
Model ERS Baseband 6648
KDU 137 0015/11

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